

SPECIFICATION

(TENTATIVE)

DEVICE NAME : Power MOSFET

TYPE NAME : 2SK2640-01MR

SPEC. No. :

Fuji Electric Co.,Ltd.

This Specification is subject to change without notice.

	DATE	NAME	APPROVED	Fuji Electric Co.,Ltd.	
DRAWN				DWG.NO.	1/12
CHECKED					

1. Scope
This specifies Fuji power MOSFET 2SK2640-01MR
2. Construction N-channel enhancement mode power MOSFET
3. Application for switching
4. Outview TO-220F Outview See to 5/12 page
5. Absolute maximum ratings at Tc=25°C (unless otherwise specified)

Description	Symbol	Characteristics	Unit	Remarks
Drain-source voltage	V _{DS}	500	V	
Continuous Drain current	I _D	± 10	A	
Pulsed drain current	I _{DD100}	± 40	A	
Gate-source voltage	V _{GS}	± 30	V	
Repetitive or non-repetitive	I _{AR}	10	A	T _{ch} ≤ 150°C
Avalanche energy	E _{AS}	77.6	mJ	See page 12/12 ※
Maximum power dissipation	P _D	50	W	
Operating and storage temperature range	T _{ch}	150	°C	
	T _{stg}	-55 ~ +150	°C	

※ L=1.42mH, Vcc=50V

6. Electrical characteristics at Tc=25°C (unless otherwise specified)
- Static ratings

Description	Symbol	Conditions	Characteristics			Unit	
			Min.	Typ.	Max.		
Drain-source breakdown voltage	B V _{DSS}	I _D = 1mA V _{GS} = 0V	500			V	
Gate threshold voltage	V _{GS(th)}	I _D = 1mA V _{DS} = V _{GS}	3.5	4.0	4.5	V	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 500V V _{GS} = 0V			10	500	μA
	I _{DSS}						
Gate-source leakage current	I _{GSS}	V _{GS} = ±30V V _{DS} = 0V		10	100	nA	
Drain-source on-state resistance	R _{DS(on)}	I _D = 5 A V _{GS} = 10 V		0.73	0.90	Ω	

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Dynamic ratings

Description	Symbol	Conditions	Characteristics			Unit
			Min.	Typ.	Max.	
Forward transconductance	g_{fs}	$I_D = 5\text{ A}$ $V_{DS} = 25\text{ V}$	2.5	5.0		S
Input capacitance	C_{iss}	$V_{DS} = 25\text{ V}$ $V_{GS} = 0\text{ V}$ $f = 1\text{ MHz}$		950	1450	pF
Output capacitance	C_{oss}			180	270	pF
Reverse transfer capacitance	C_{rss}			80	120	pF
Turn-on time	$t_{d(on)}$	$V_{CC} = 300\text{ V}$ $V_{GS} = 10\text{ V}$ $I_D = 10\text{ A}$ $R_{GS} = 10\ \Omega$		25	40	ns
	t_r			70	110	ns
Turn-off time	$t_{d(off)}$			70	110	ns
	t_f			45	70	ns

Reverse diode

Description	Symbol	Conditions	Characteristics			Unit
			Min.	Typ.	Max.	
Avalanche capability	I_{AV}	$L = 100\ \mu\text{H}$, $T_{CH} = 25^\circ\text{C}$ * See Fig1 and 2	10			A
Diode forward on-voltage	V_{SD}	$I_F = 2 \times I_{DR}$ $V_{GS} = 0\text{ V}$, $T_{CH} = 25^\circ\text{C}$		1.1	1.65	V
Reverse recovery time	t_{rr}	$I_F = I_{DR}$ $V_{GS} = 0\text{ V}$ $-dI_F/dt = 100\text{ A}/\mu\text{s}$ $T_{CH} = 25^\circ\text{C}$		450		ns
Reverse recovery charge	Q_{rr}				5.5	

7. Thermal resistance

Description	Symbol	Conditions	Characteristics			Unit
			Min.	Typ.	Max.	
Thermal resistance	$R_{th_{ch-c}}$				2.5	$^\circ\text{C}/\text{W}$
	$R_{th_{ch-a}}$				62.5	$^\circ\text{C}/\text{W}$

Fig.1 Test circuit

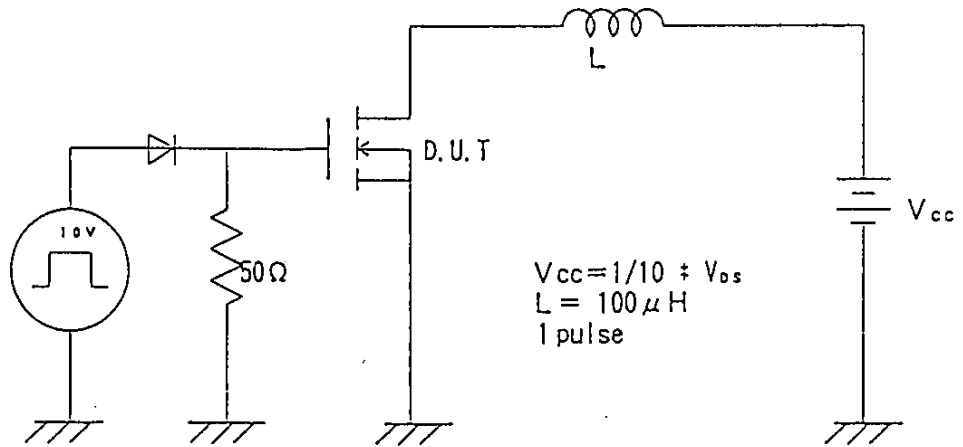
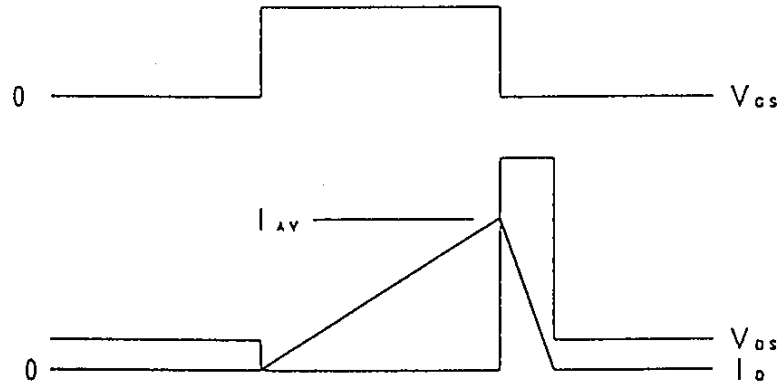
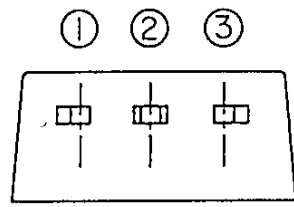
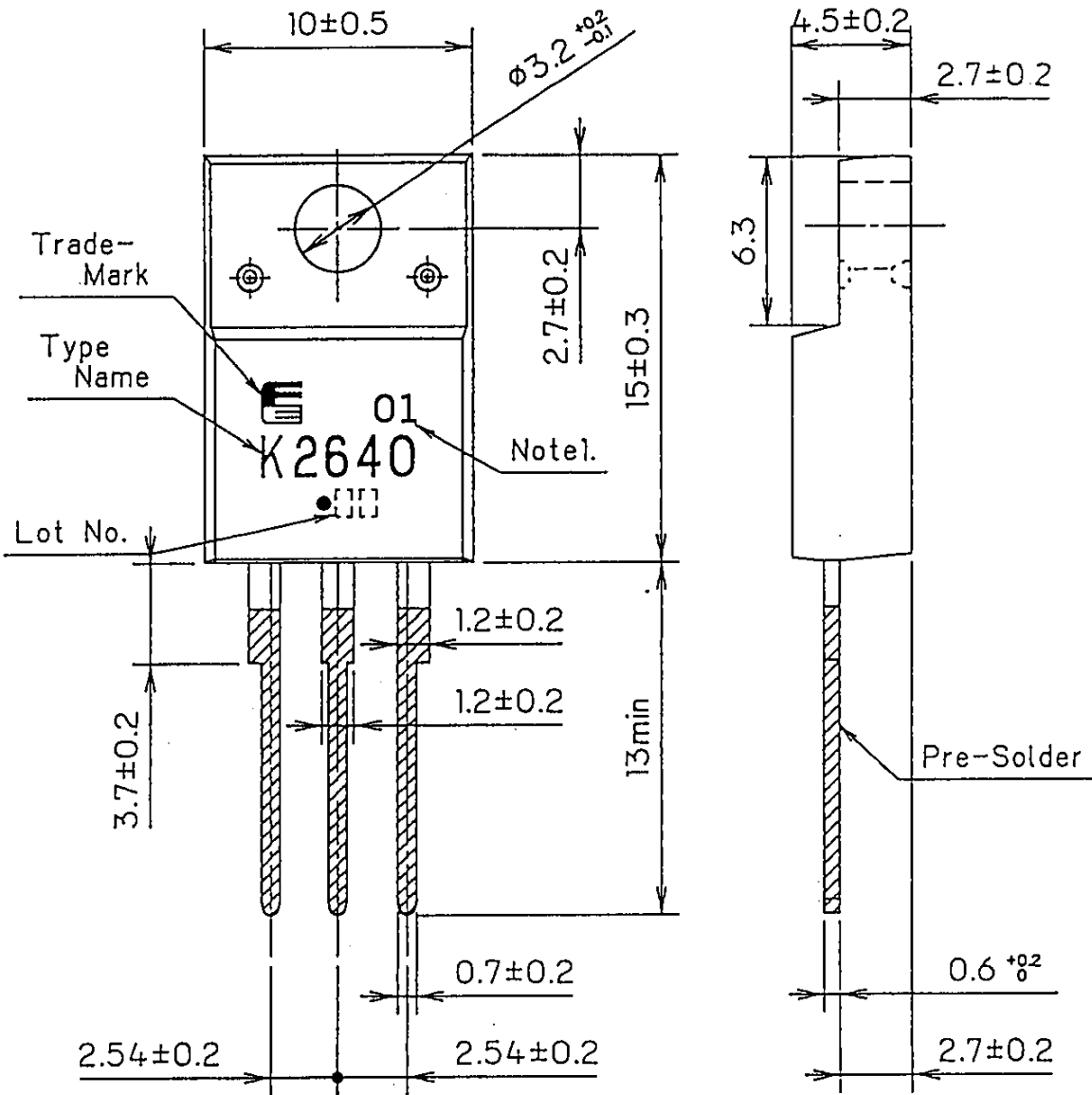


Fig.2 Operating waveforms



FUJI POWER MOS FET

TYPE : 2SK2640-01MR



CONNECTION

- ① GATE
- ② DRAIN
- ③ SOURCE

Note 1. Guaranteed mark of avalanche ruggedness.

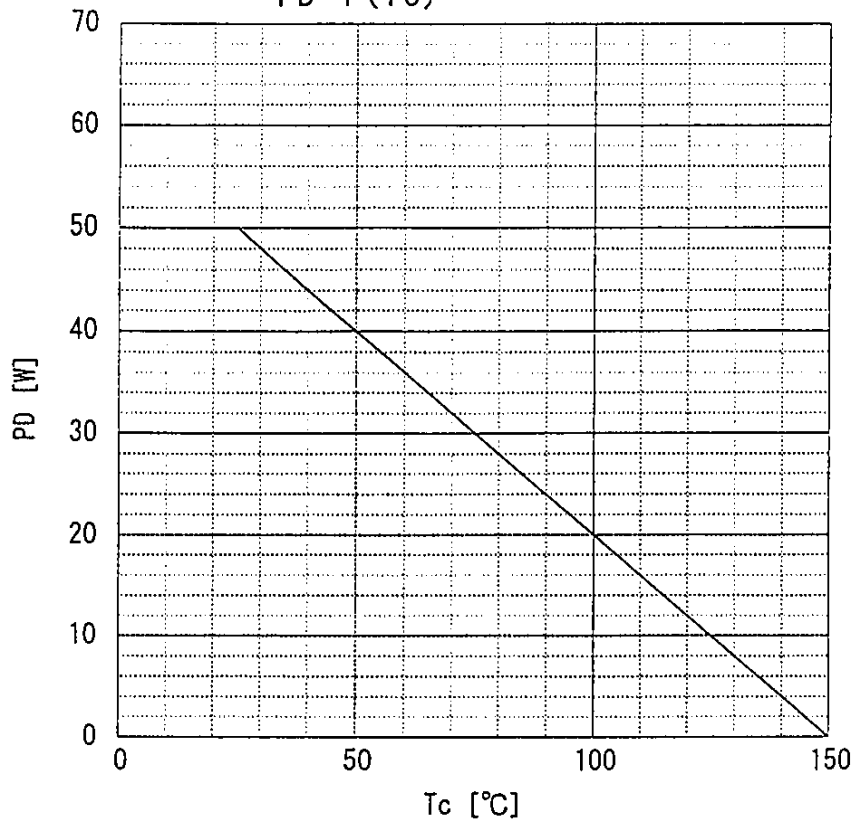
DIMENSIONS ARE IN MILLIMETERS.

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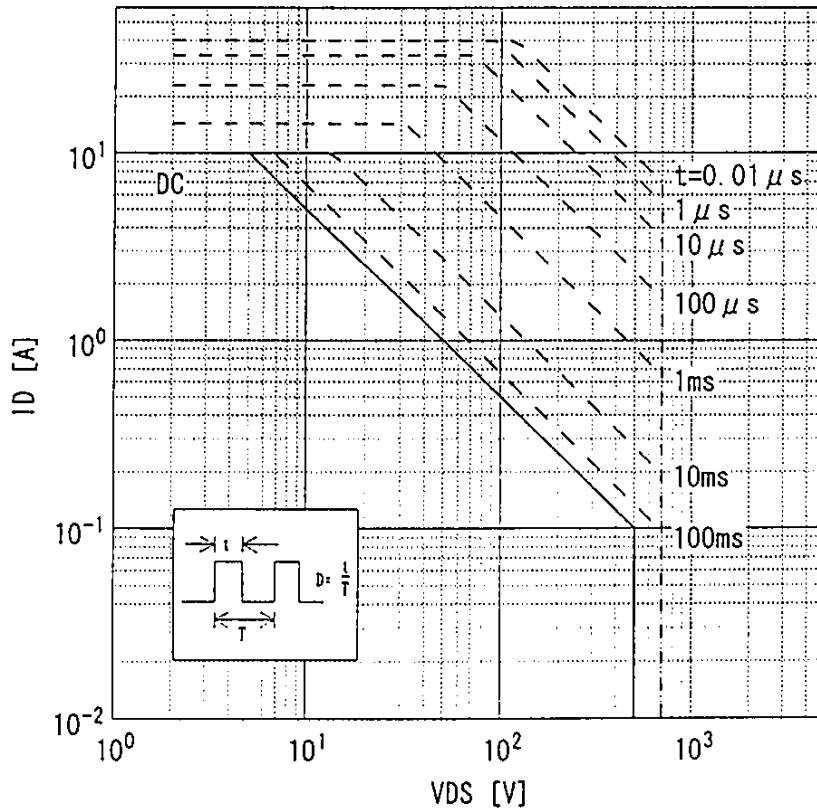
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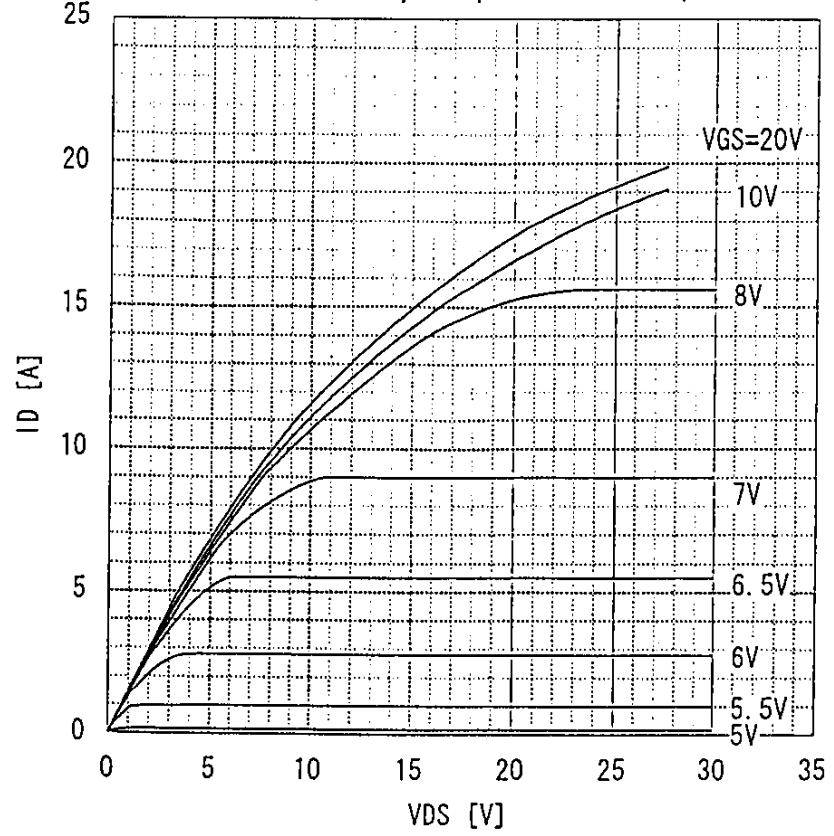
Power Dissipation
 $PD=f(T_c)$



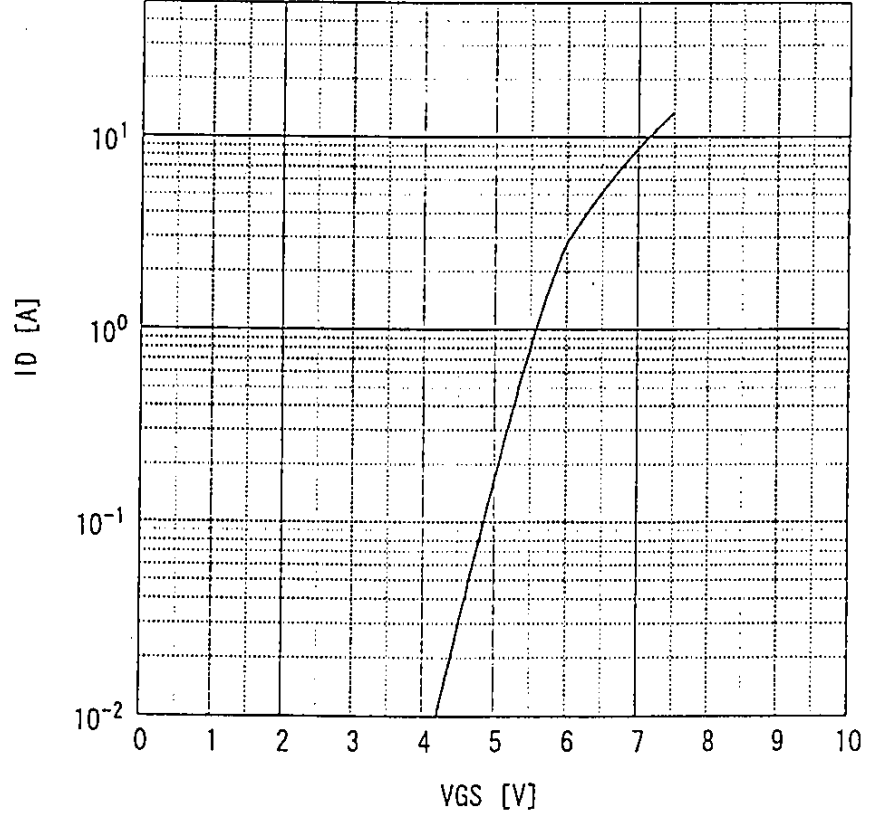
Safe operating area
 $ID=f(V_{DS}) : D=0.01, T_c=25^\circ\text{C}$



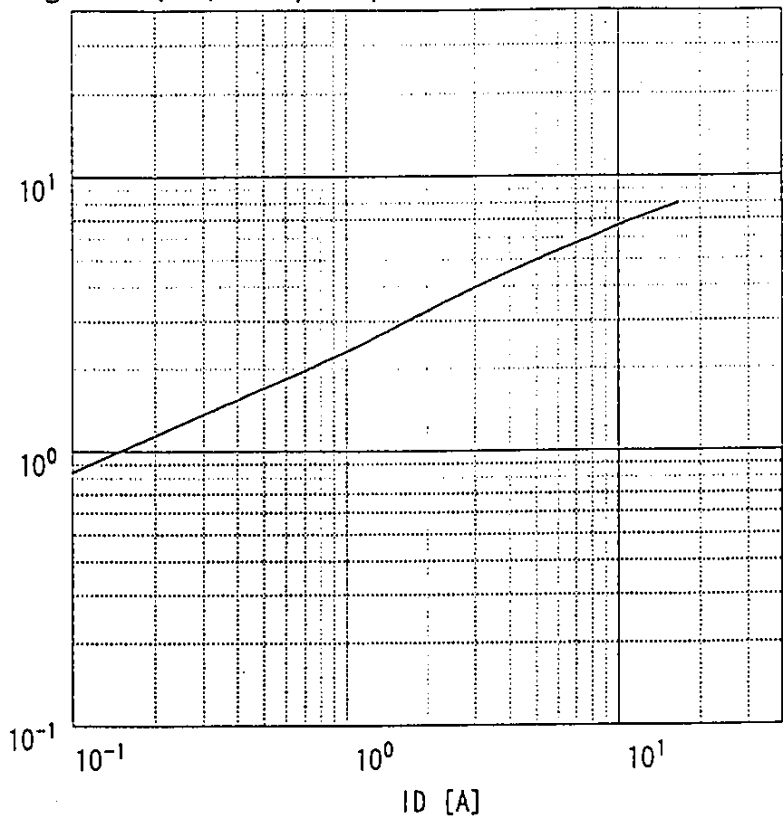
Typical output characteristics
 $I_D = f(V_{DS})$: 80 μ s pulse test, $T_c = 25^\circ\text{C}$



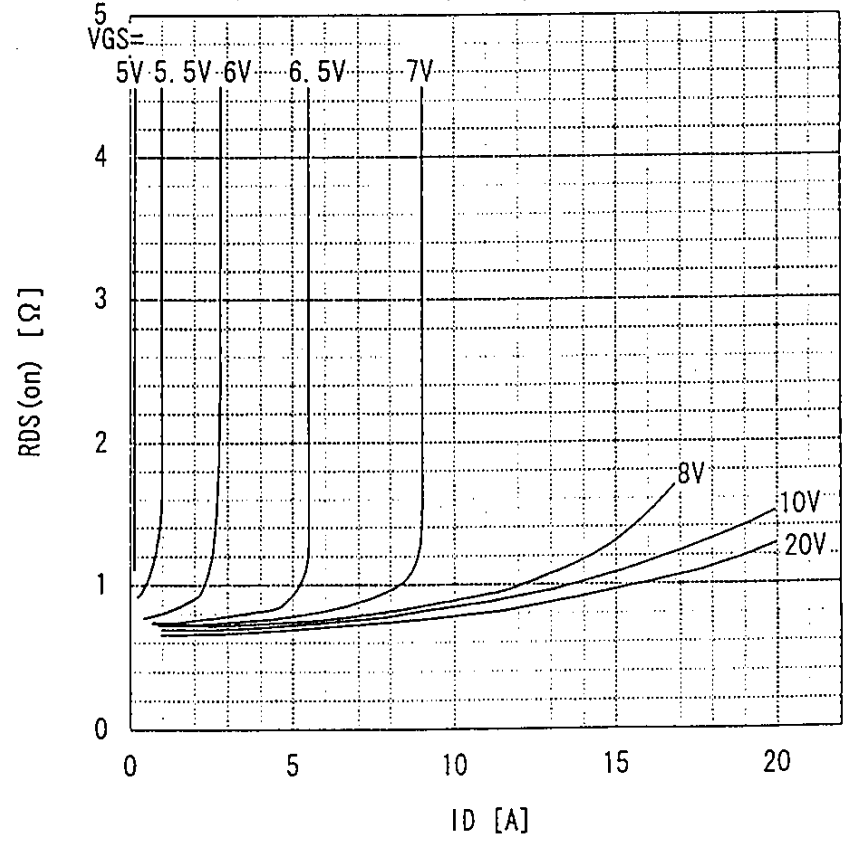
Typical transfer characteristic
 $I_D = f(V_{GS})$: 80 μ s pulse test, $V_{DS} = 25V$, $T_{ch} = 25^\circ\text{C}$



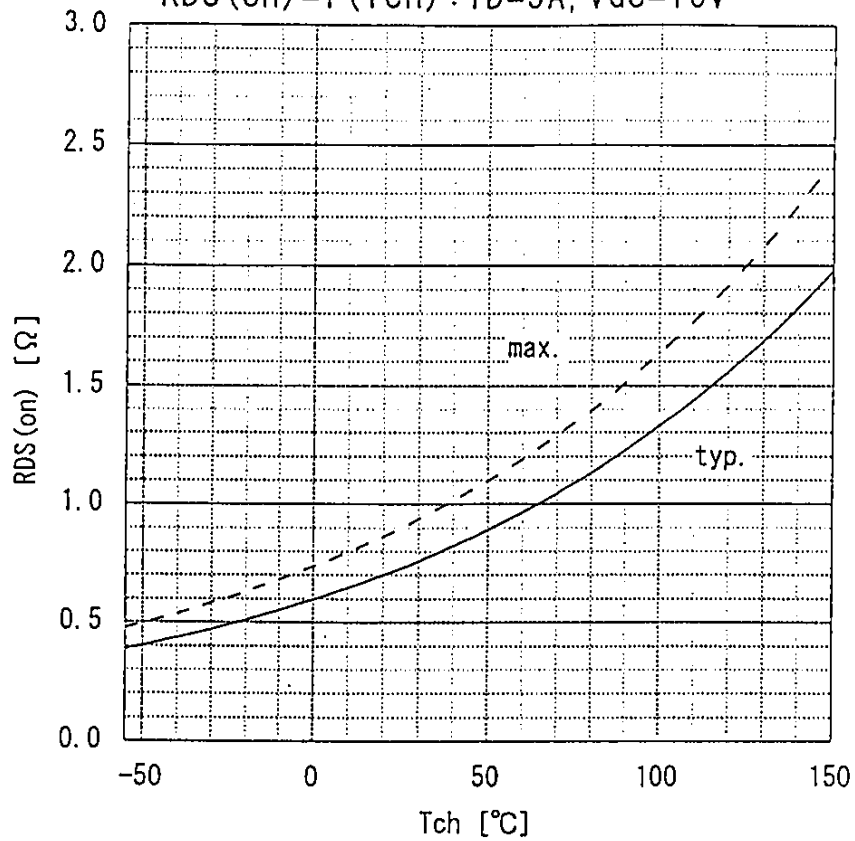
Typical forward transconductance
 $g_{fs}=f(I_D)$: 80 μ s pulse test, $V_{DS}=25V$, $T_{ch}=25^\circ C$



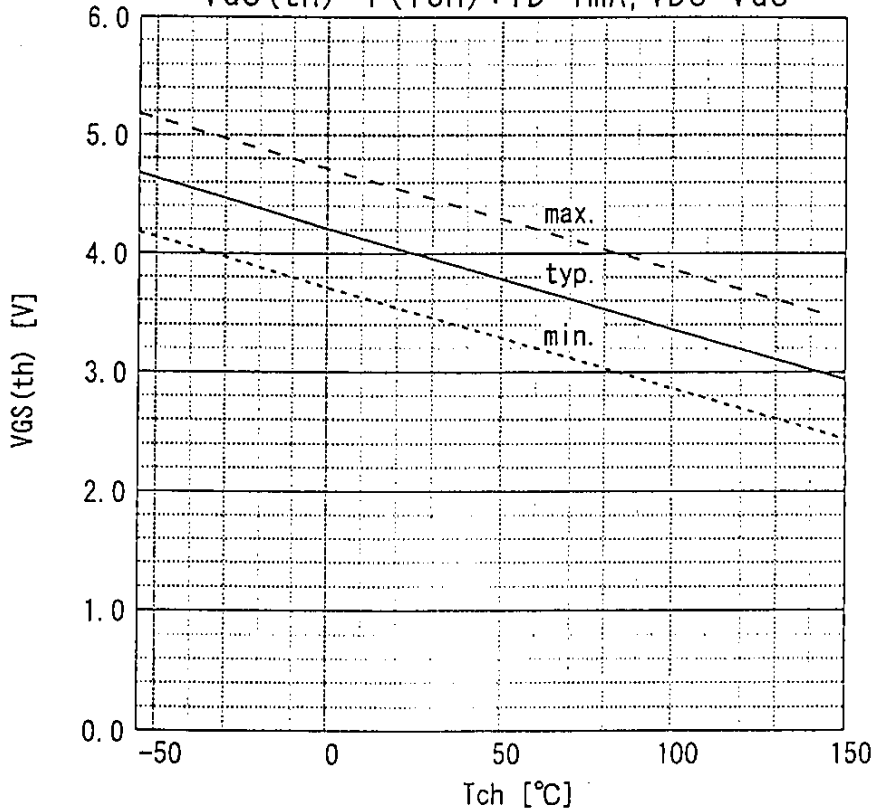
Typical drain-source on-state resistance
 $R_{DS(on)}=f(I_D)$: 80 μ s pulse test, $T_c=25^\circ C$



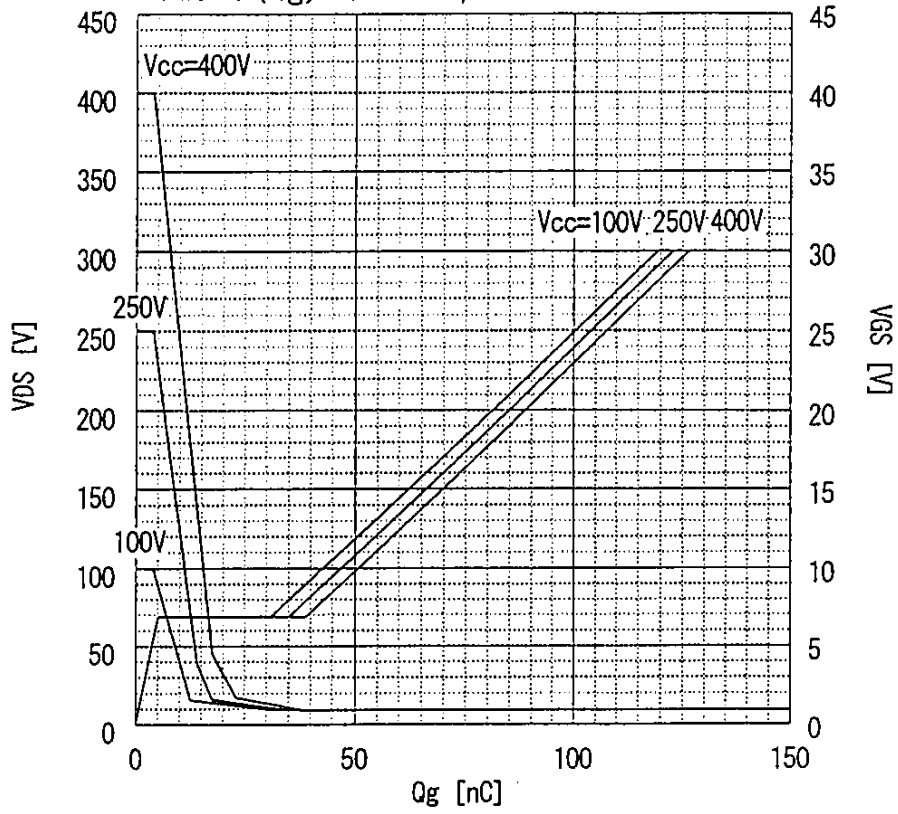
Drain-source on-state resistance
 $R_{DS(on)} = f(T_{ch}) : I_D = 5A, V_{GS} = 10V$



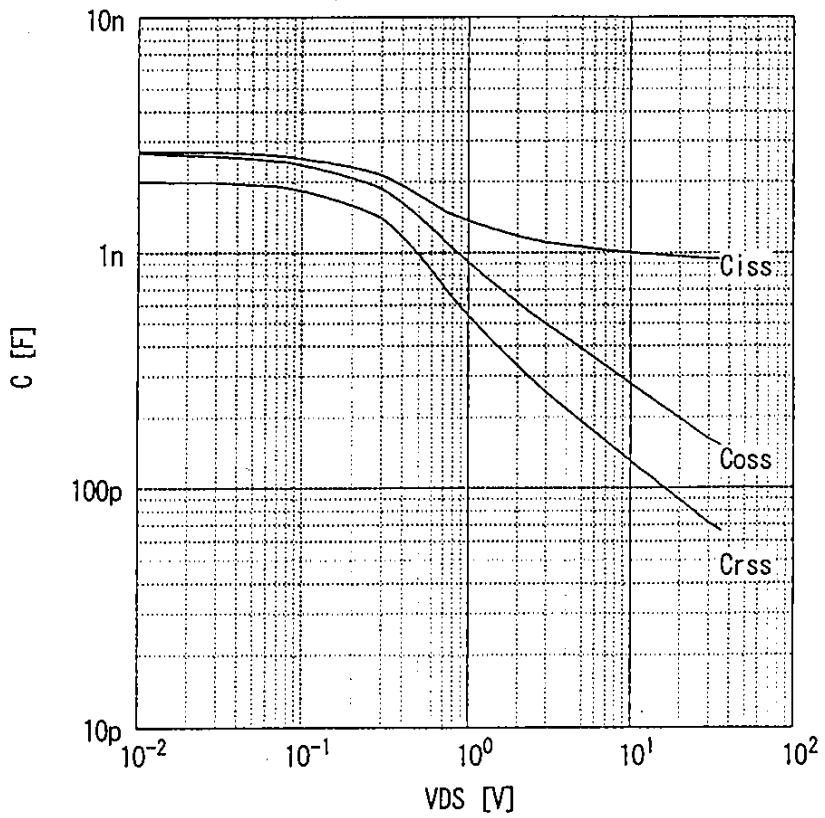
Gate threshold voltage
 $V_{GS(th)} = f(T_{ch}) : I_D = 1mA, V_{DS} = V_{GS}$



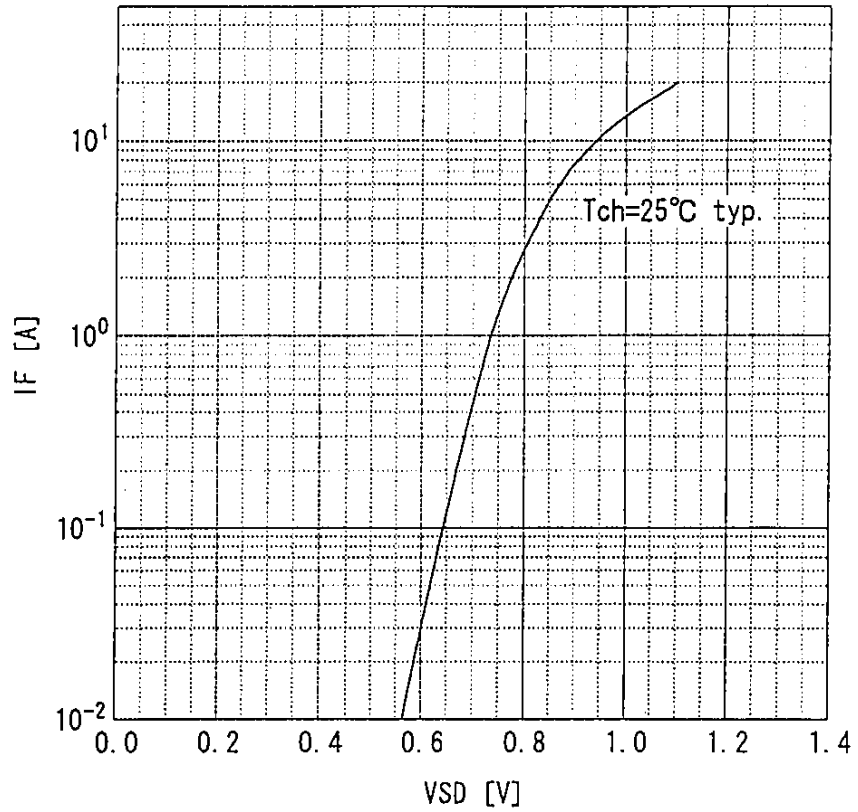
Typical gate charge characteristic
 $V_{GS} = f(Q_g) : I_D = 10A, T_c = 25^\circ C$



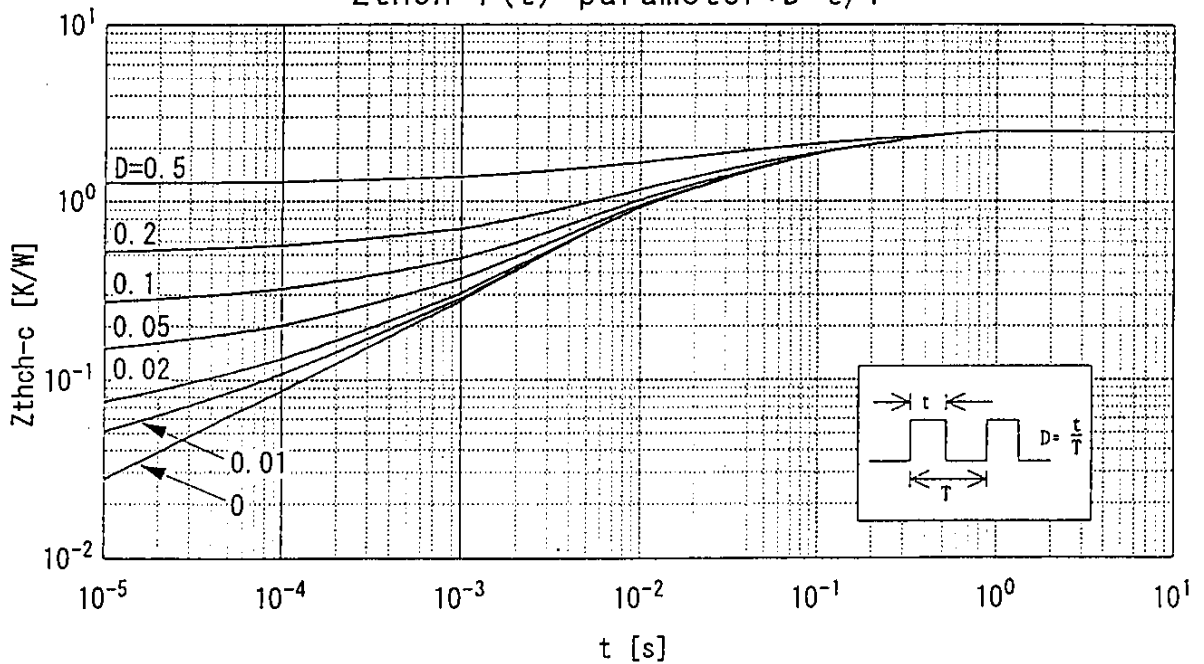
Typical capacitances
 $C = f(V_{DS}) : V_{GS} = 0V, f = 1MHz$



Forward characteristic of reverse of diode
 $I_F = f(V_{SD}) : 80 \mu s$ pulses test, $V_{GS} = 0V$



Transient thermal impedance
 $Z_{thch} = f(t)$ parameter: $D = t/T$



Avalanche energy derating
 $E_{as}=f(\text{starting } T_{ch}): V_{CC}=50V, I_{AV}=10A$

